APPLIC/	ABLE STA	NDARD									
	OPERATING TEMPERATURE RANGE OPERATING HUMIDITY RANGE		-40°C TO + 85°C (NOTE	1) _{TEMF}	STORAGE TEMPERATURE RANGE		-10°	-10°C TO + 60°C (NOTE			
RATING			40% TO 80% (NOTE 3)		STORAGE HUMIDITY RANGE		40% TO 70% (NOTE 2)			1	
\$	VOLTAGE		250V AC/DC		004	VOLTAG	E	30V AC			
	CURRENT		AWG#22 : 2A AWG#24-28 : 1A AWG#30 : 0.5A	UL · (CURREN	Т	AWG#22 : AWG#24-28 : AWG#30 :			
	APPLICAE CONNECT		DF11-**DS-2C (##)		APPLICABLE CONTACT		ı	DF11-**SC(F)(
			SPECIF		_						
I	TEM		TEST METHOD			REQUIREMENTS				AT	
CONSTI	RUCTION	l			•						
GENERAL EXAMINATION		VISUALLY	VISUALLY AND BY MEASURING INSTRUMENT.			ACCORDING TO DRAWING.				Х	
MARKING			CONFIRMED VISUALLY.					X	X		
		RACTERIS							1	1	
CONTACT RESISTANCE		E 100mA ([100mA (DC OR 1000 Hz).			30mΩ MAX.				-	
INSULATION		500V DC	500V DC.			1000MΩ MIN.				_	
RESISTANCE VOLTAGE PROOF		650V AC	650V AC FOR 1 min.			NO FLASHOVER OR BREAKDOWN.				-	
MECHANICAL CHAI						INO I LAGITOVEN ON BREAKDOWN.					
MECHAIC MECHANIC				TIONE	1 001	TAOT DC	CICTANCE	. 20ma MAN		1	
OPERATION		301 IMES	30TIMES INSERTIONS AND EXTRACTIONS.			 CONTACT RESISTANCE: 30mΩ MAX. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 				_	
			FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.			NO ELECTRICAL DISCONTINUITY OF 1 µs. NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				_	
			490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.			 NO ELECTRICAL DISCONTINUITY OF 1μs. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 				-	
FNVIRC	NMENTA	L CHARA	ACTERISTICS		OF P.	ARIS.					
DAMP HE			D AT 40 ± 2 °C, 90 TO 95 %	6, 96 h.	① CON	TACT RES	SISTANCE:	30mΩ MAX.	X		
(STEADY STATE)						 ② INSULATION RESISTANCE: 500MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 				-	
TEMPERATURE T		TIME				 CONTACT RESISTANCE: 30mΩ MAX. INSULATION RESISTANCE: 1000MΩ MIN. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 				_	
RESISTANCE TO		1)AUTON	1)AUTOMATIC SOLDERING (FLOW)			NO DEFORMATION OF CASE OF					
SOLDERING HEAT		IMMEF 2)MANUA SOLDE SOLDE	SOLDER TEMPERATURE: 260°C FOR IMMERSION, DURATION, 10 sec. 2)MANUAL SOLDERING SOLDERING IRON TEMPERATURE: 300°C SOLDERING TIME: 2 sec. NO STRENGTH ON CONTACT.			EXCESSIVE LOOSENESS OF THE TERMINALS.				_	
SOLDERABILITY SO		SOLDER	ERED AT SOLDER TEMPERATURE, FOR INSERTION DURATION, 3sec.			SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.				-	
001"	NT.	DECODIDE	ON OF DEVISIONS	חבס		,_ <u></u> ,	01.17	CKED		 \TE	
COUI	N I		DN OF REVISIONS					CHECKED SZ. 0N0		ATE 07. 20	
REMARKS					m11V//1			ROVED KJ. KATAYOSE		01. 05	
NOTE2: APPLY AFTER	TO THE COND R MOUNTED ON	PCB, OPERATIO	TERM STORAGE FOR UNUSED PROD ON TEMPERATURE AND HUMIDITY RA	FOR UNUSED PRODUCTS BEFORE MOUNTED ON F RE AND HUMIDITY RANGE IS APPLIED FOR INTERIM		N PCB.	HECKED	TY. OMA		05. 01. 05	
STORAGE DURING TRANSPORTATIO NOTE3:NON-CONDENSING. Jnless otherwise specified , refer to l					DES		IO. DENPOUYA	05. 01. 05			
Note QT:Qualification Test AT:			surance Test X:Applicable Tes	DRAW	DRAWING NO. ELC4-0			34377-01			
HS		SPECIFI	CATION SHEET	TION SHEET PAR		T NO. D		DF11-**DP-2DSA (08)			
HIR			<u> </u>			E NO.					